



ENGINEERING DEPT. REVISIONS ECNT120150

PRODUCT SPECIFICATION For CU11 HDMI Right Angle Series

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1. SCOPE:

This specification covers the product performance, tests methods and quality requirements of the HDMI C Type Series connector.

2. APPLICABLE STANDARDS

MIL - STD - 202	Test methods for electrical component parts
EIA-364	Test methods for electrical connectors
EIA - RS - 364	Test methods for electrical connectors
J-STD-020	Resistance to soldering Temperature for through hole Mounted Devices
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design
	standards

3. APPLICABLE SERIES NO.: CU11SAH1UF0

- 4. SHAPE, CONSTRUCTION AND DIMENSIONS See attached drawings
- 5. MATERIALS See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")6.2 P.C. Board Layout: See attached drawings

REVIEWED : <u>Eisley</u> APPROVED : <u>Sun</u> VERIFIED : <u>Jessie</u> .



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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT		
7.1	Rated current and voltage		0.5A. 40V AC.		
7.2	Contact resistance	Mate connectors Contacts: Measure by dry circuit, 20m Volts Max. 10mA. EIA-RS-364-23B	Contacts: 30 mΩ Max. (before & after)		
		Mate connectors Shell : Measure by open circuit, 5Volts Max.100mA EIA-RS-364-23B	Shell : 30 mΩ Max. (before & after)		
7.3	Dielectric strength	Unmated connectors, Apply 500 Volts AC (R.M.S.) for 1minute between adjacent terminal or ground. Mated connectors, Apply 300 Volts AC (R.M.S.) for 1 minute between adjacent terminal and ground. EIA-RS-364-20C	No breakdown		
7.4	Insulation resistance	Unmated connectors, Apply 500Volts DC between adjacent terminal or ground. EIA-RS-364-21C	Unmated: 100 MΩ Min.		
		Mated connectors, Apply 150Volts DC between adjacent terminal or ground. EIA-RS-364-21C	Mated: 10 MΩ Min.		

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	
8.1	Insertion / Withdrawal Force	The force shall be measured with the plug at rate of 25mm/minute. This test shall be made in a direction along the axis of both the socket and the plug. After 4 times, mating force and un-mating force shall be measure. EIA-RS-364-13A	Appearance: No damage Insertion force: 4.5 kgf Max. Withdrawal force: 1.0~4.0 kgf	
8.2	Durability	Measure contact and shell resistance after Following. Automatic cycling: Type A:10,000 cycles at 100±50 cycles per hour EIA-RS-364-09A	Appearance: No damage Contact resistance : Contact: 30 mΩ Max. (before & after) Shell: 30 mΩ Max. (before & after)	



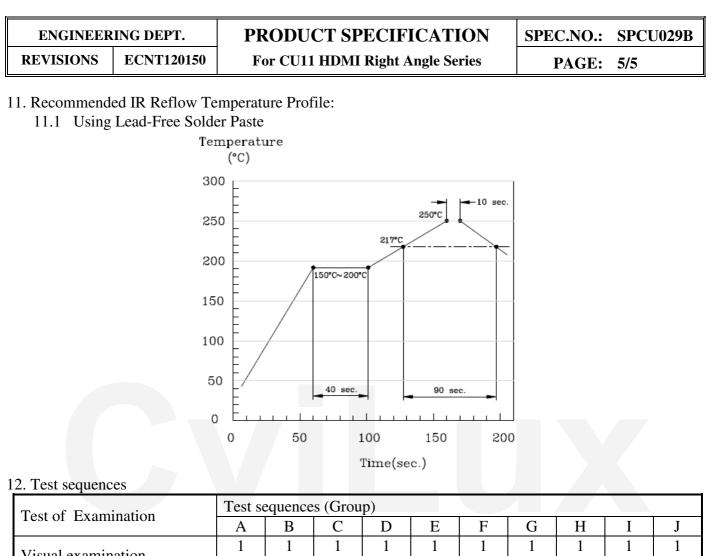
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). EN	VIRONMI	ENTAL PE	ERFOI	RMANCE:				
	ITE	EM		TEST CONDITION	REQUI	REMENT		
9.1	Vibration		Ampl	itude: 1.52mm P-P or 147m/s ² (15G)	Appearance: No damage.			
			Sweep time: 50-2000-50Hz in 20 minutes.		Contact resistance:			
		Duration: 12 times in each $X \times Y \times Z$ axes.			Contact: 30 m Ω Max.			
			(total	of 36 times)	(before & afte	er)		
				ical load: DC 100mA current shall be flowed	Shell: $30 \text{ m}\Omega$			
				g the test. EIA-RS-364-28	(before & afte	<i>`</i>		
					Discontinuity	:1 μsec max.		
9.2	Solder abi	2		ring time: 5 ± 0.5 seconds	Minimum:			
				ring pot: 245 ± 5 °C	95% of immersed area			
			MIL-S	STD-202F, Method 208				
9.3	Humidity	7		specimens shall be placed in a chamber and	Appearance: No damage.			
				exted to a relative humidity of 90% to 95% a temperature of 40 ± 2 °C for 96 hours then	Insulation res	sistance:		
				and in ambient temperature for more than 1	$100 \text{ M}\Omega \text{ Mir}$	n (before &		
			hour.		after) Contact resis	tanaa		
					Contact Tesis			
					(before & afte			
					Shell: 30 m			
			EIA-	RS-364-31A	(before & after)			
9.4	Salt spray	J	Tem	perature: $35 \pm 3^{\circ}C$	Appearance: No damage			
<i>.</i>	Suitspiuj	,	Solut	tion: $5 \pm 1\%$	Contact resis	stance:		
			Spray	y time: 48 ± 4 hours	Less than twi	ice of initial		
			(Stan	nping before plated)				
			Sprag	y time: 24 ± 4 hours				
			(Stan	nping after plated)				
				connectors and expose to the following salt				
				conditions. Upon completion of the exposure				
			d, salt deposits shall be removed by a gentle or dip in running water and dried naturally,					
				which the specified measurements shall be				
				ormed.				
				specimens shall be suspended from the top				
			-	waxed twine, string or nylon thread.				
				test only define the plating area, without ng area (as copper cross section) will not be				
			defin	• • • • • • • • • • • • • • • • • • • •				
				364-26B / MIL-STD-202 Method 101)				



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		ITEM	TEST CONDITION	REQUIREMENT		
9.5	Resistance heat	e to soldering	The connector shall be tested resistance. To soldering heat in the following conditions. Soldering time: 10 second. Soldering pot: 250°C Refer Reflow temperature profile(11.1)	Appearance: No evidence of physical damage		
9.6 Temperature life (heat)		ure life	The specimens shall be subjected to a temperature of 105±5 °C for 250 hours, then placed in ambient temperature for more than 3 hours.	Appearance: No damage Insulation resistance: 100 MΩ Min (before & after) Contact resistance: Contact: 30 mΩ Max. (before & after)		
			MIL-STD-1344A, Method 1005.1	Shell: 30 mΩ Max. (before & after)		
9.7	Temperature life (Cold)		The specimens shall be subjected to a temperature of -25 for 96 hours, then placed in ambient temperature for more than 3 hours.	Appearance: No damage		
				Contact resistance: Contact: $30 \text{ m}\Omega \text{ Max}$. (before & after) Shell: $30 \text{ m}\Omega \text{ Max}$.		
			MIL-STD-1344A, Method 1005.1	(before & after)		

10. AMBIENT TEMPERATURE RANGE: Operating Temperature: -25°C to +85°C





Tost of Examination		1	(-	r/						
Test of Examination	Α	В	С	D	E	F	G	Η	Ι	J
Visual examination	1	1	1	1	1	1	1	1	1	1
	3	5	3	3	3	5	5	3	5	5
Contact resistance		2 4					24			
Insulation resistance						2 4			2 4	2 4
Dielectric strength	2									
Durability		3								
Insertion / Withdrawal Force			2							
Vibration				2						
Solder ability					2					
Humidity						3				
Salt Spray							3			
Resistance to Soldering Heat								2		
Temperature Life (Heat)									3	
Temperature Life (Cold)										3